CONSMB006-G ACTIVE

TE Internal #: CONSMB006-G

SMB RF Interface, Plug, 50 Ω , Snap-On, 4 GHz Operating

Frequency, 1 Position, Printed Circuit Board, Board Mount, -65 –

165 °C [-85 – 329 °F], Solder

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Connectors > RF Connectors > Coax Connectors





RF Interface: SMB

RF Connector Style: Plug

Impedance: 50Ω

RF Connector Coupling Mechanism: Snap-On

Operating Frequency: 4 GHz

Features

Product Type Features

Connector Product Type	Connector Assembly
RF Interface	SMB
RF Connector Style	Plug
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

PCB Mount Orientation	Vertical
Number of Positions	1
Number of Coaxial Contacts	1

Electrical Characteristics

Impedance	50 Ω	

Body Features

Cable Connector Orientation	Straight
Body Material	Brass
Body Material Finish	Plated
Body Plating Material	Gold

Contact Features

RF Connector Center Contact Plating Material	Gold



RF Connector Center Contact Material	Beryllium Copper
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Solder
Termination Method to Wire & Cable	Solder
Mechanical Attachment	
RF Connector Coupling Mechanism	Snap-On
Connector Mounting Type	Board Mount
RF Contact Captivation Method	Mechanical
Detent	Without
Usage Conditions	
Operating Temperature Range	-65 – 165 °C[-85 – 329 °F]
Operation/Application	
Operating Frequency	4 GHz
Circuit Application	Signal
Packaging Features	
Packaging Quantity	100
Packaging Method	Tray
Other	
Dielectric Material	PTFE

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability



Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

Compatible Parts



Customers Also Bought















TE Part #1SNA103323R2300 AF50 SMB RF Interface, Plug, 50 Ω , Snap-On, 4 GHz Operating Frequency, 1 Position, Printed Circuit Board, Board Mount, -65 – 165 °C [-85 – 329 °F], Solder



TE Part #1SNA103332R2400 FEF 12-1

Documents

Product Drawings

SMB Plug 50 Ohm PCB Through Hole

English

Datasheets & Catalog Pages

SMB Plug PCB Through Hole Connector

English